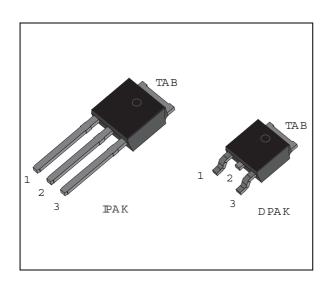


Fire lighter circuit

Datasheet - production data



Features

- Dedicated thyristor structure for capacitance discharge ignition operation
- High pulse current capability:
 - 190 A at $t_p = 10 \mu s$
- Fast turn-on operation
- Designed for high ambient temperature (up to 120° C)

Benefits

- Space saving thanks to monolithic function integration
- · High reliability with planar technology

Description

The FLC01 series has been especially developed for capacitance discharge operation. The main applications are gas lighters or ignitors such as cookers / gas boilers / gas hobs...

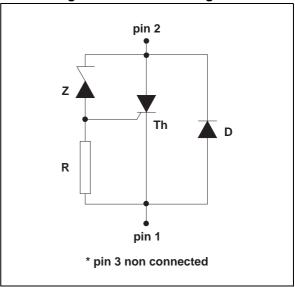
It provides a fully integrated function, with high performance and reliability levels, adapted to severe and hot temperature environment.

- **Th:** Thyristor for switching operation
- **Z**: Zener diode to set the threshold voltage
- D: Diode for reverse conduction
- R: 2 kΩ resistor

Table 1. Device summary

Symbol	Value	Unit
I _{T(rms)}	4	Α
V_{DRM}, V_{RRM}	600	V
I _{GT}	5	mA

Figure 1. Functional diagram



Characteristics FLC01

1 Characteristics

Table 2. Absolute ratings (limiting values)

Symbol	Parameter		Value	Unit
I _{TRM}	$I_{TRM} \begin{tabular}{ll} Repetitive surge peak on state current for thyristor \\ -30° C \le T_{amb} \le 120° C \end{tabular} t_p = 10 \ \mu s \\ I_{FRM} \begin{tabular}{ll} Repetitive surge peak on state current for diode \\ -30° C \le T_{amb} \le 120° C \end{tabular} \begin{tabular}{ll} (Figure 3) \end{tabular}$		190	A
I _{FRM}			190	
dl/dt	Critical rate of rise time on state current -30° C \leq T _{amb} \leq 120° C	120	A/µs	
T _{stg} T _j	Storage junction temperature range Maximum junction temperature	- 40 to + 150 + 125	° C	
T _{oper}	Operating temperature range	- 30 to + 120	° C	
T _L	Maximum lead temperature for soldering during 10s		260	° C

Table 3. Thermal resistance

Symbol	Parameter		Min.
R _{th(j-a)}	Thermal resistance junction to ambient	100	° C/W

Figure 2. Electrical characteristics (definitions)

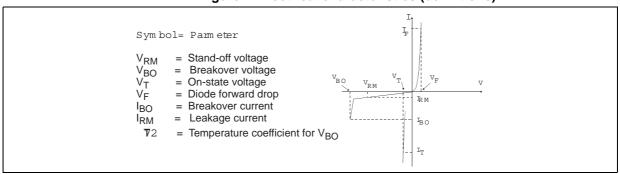


Table 4. Electrical characteristics: diode (D) parameter

Symbol	Test Conditions				Value	Unit
V _F	I _F = 2 A	$t_p \le 500 \ \mu s$	T _j = 25° C	MAX	1.7	V

Table 5. Electrical characteristics: Thyristor (Th) and Zener (Z) parameters

Symbol	Test Condition	Min.	Тур.	Max	Unit	
I _{RM}	V _{RM} = 200 V	T _j = 25° C			1	μΑ
	V _{RM} = 200 V	T _j = 125° C			10	μΑ
V _{BO}	at I _{BO}	T _j = 25° C	206	220	233	V
I _{BO}	at V _{BO}	T _j = 25° C			0.5	mA
V _T	$I_T = 2 \text{ A}$ $t_p \le 500 \mu\text{s}$	T _j = 25° C			1.7	V
αΤ		·		0.27		V/° C

FLC01 Characteristics

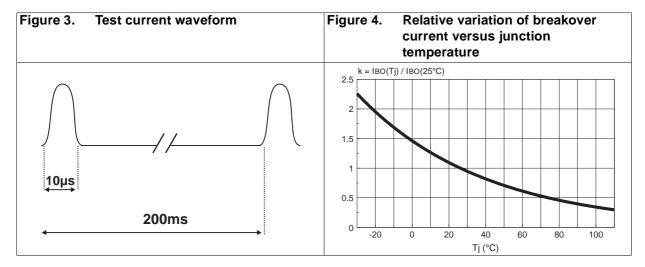
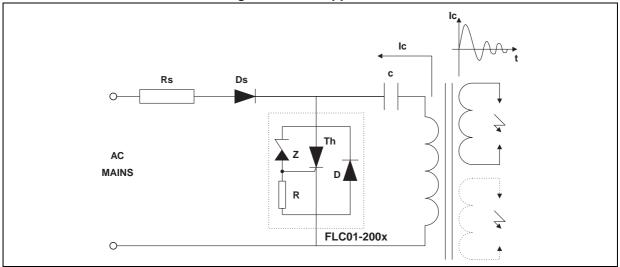


Figure 5. Basic application



Characteristics FLC01

The applications of the lighter using the capacitance discharge topology operate in 2 phases:

Phase 1

The energy coming from the mains is stored into the capacitor C. For that, the AC voltage is rectified by the diode Ds.

Phase 2

At the end of the phase 1, the voltage across the capacitor C reaches the avalanche threshold of the zener. Then a current flows through the gate of the thyristor Th which fires.

- The firing of the thyristor causes an alternating current to flow through the capacitor C
- The positive parts of this current flow through C, Th and the primary of the HV transformer
- The negative parts of the current flow through C, D and the primary of the HV transformer

RS resistor calculation

The Rs resistor allows, in addition with the capacitor C, the spark frequency to be adjusted and the current from the mains to be limited. Its value shall allow the thyristor Th to fire even in the worst case. In this case the system must fire with the lower RMS mains voltage value while the breakdown voltage and current of the FLC are at the maximum.

The maximum Rs value is equal to:

$$Rsmax = \frac{\left(V_{AC} \; min \cdot \sqrt{2}\right) - \left[V_{BO} max \cdot (1 + \alpha T \cdot (T_{amb} - 25))\right]}{k \cdot I_{BO} \left(1\right)}$$

(1) See Figure 4

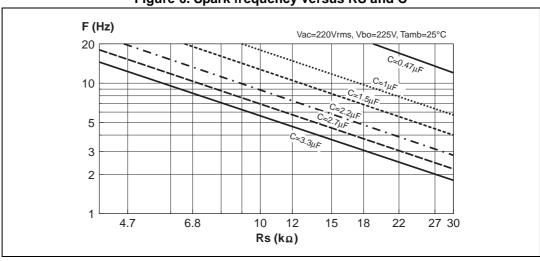


Figure 6. Spark frequency versus RS and C

The couple Rs/C can be chosen with the previous curve.

Keep in mind the Rs maximum limit for which the system would not work when the AC mains is minimum.

FLC01 **Characteristics**

The next curve on the next page shows the behavior with RS = 15 k Ω and C = 1 μ F.

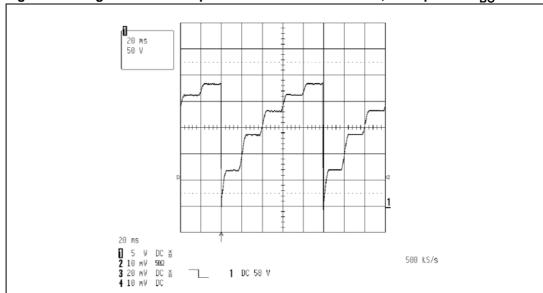


Figure 7. Voltage across the capacitance with Rs = Rs 15 k Ω , C = 1 μ F and V $_{BO}$ = 225 V

Peak current limit

This component is designed to withstand $I_{TRM} = 190$ A for a pulse duration of 10 μ s for an ambient temperature of 120° C in repetitive surge. The curve of peak current versus the pulse duration allows us to verify if the application is within the FLC operating limit.

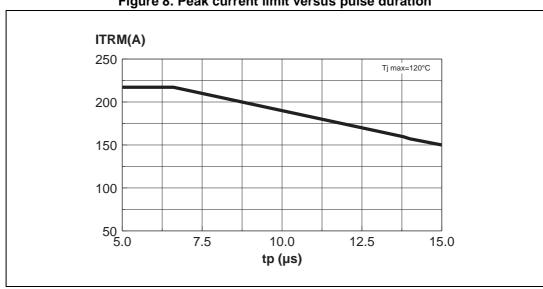


Figure 8. Peak current limit versus pulse duration

Power losses (for 10 µs, see Figure 3)

To evaluate the power losses, please use the following equations:

- For the thyristor: $P = 1.18 \times I_{T(AV)} + 0.035 I_{T(RMS)}^2$
- For the diode: $P = 0.67 \times I_{F(AV)} + 0.106 I_{F(RMS)}^2$

Package information FLC01

Package information 2

- Epoxy meets UL94, V0
- Lead-free package
- Recommended torque: 0.4 to 0.6 N·m

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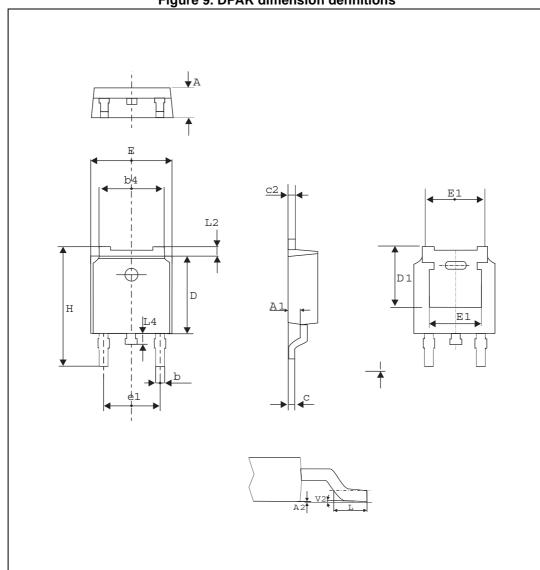


Figure 9. DPAK dimension definitions

Note:

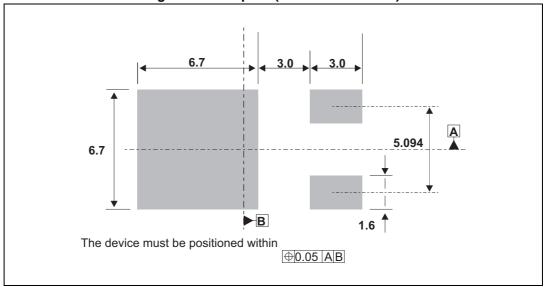
this package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

FLC01 Package information

Table 6. DPAK dimension values

Dimensions						
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	2.18		2.40	0.086		0.094
A1	0.90		1.10	0.035		0.043
A2	0.03		0.23	0.001		0.009
b	0.64		0.90	0.025		0.035
b4	4.95		5.46	0.195		0.215
С	0.46		0.61	0.018		0.024
c2	0.46		0.60	0.018		0.023
D	5.97		6.22	0.235		0.244
D1	5.10			0.201		
Е	6.35		6.73	0.250		0.264
E1		4.32			0.170	
e1	4.40		4.70	0.173		0.185
Н	9.35		10.40	0.368		0.409
L	1.00		1.78	0.039		0.070
L2			1.27			0.05
L4	0.60		1.02	0.023		0.040
V2	0°		8°	0°		8°

Figure 10. Footprint (dimensions in mm)



Package information FLC01

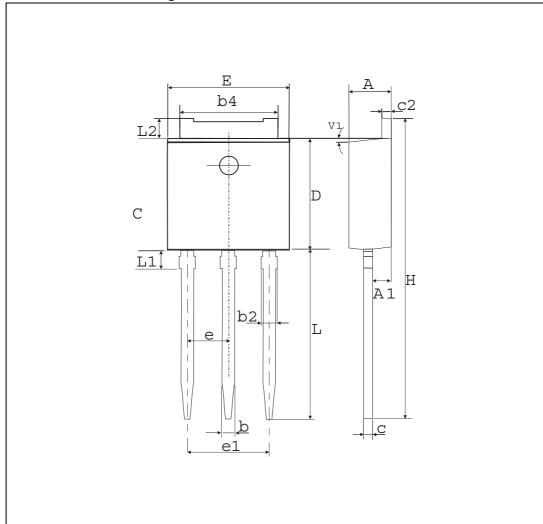


Figure 11. IPAK dimension definitions

Note:

this package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

FLC01 Package information

Table 7. IPAK dimension values

	Dimensions						
Ref.		Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α	2.20		2.40	0.086		0.094	
A1	0.90		1.10	0.035		0.043	
b	0.64		0.90	0.025		0.035	
b2			0.95			0.037	
b4	5.20		5.43	0.204		0.213	
С	0.45		0.60	0.017		0.023	
c2	0.46		0.60	0.018		0.023	
D	6		6.20	0.236		0.244	
Е	6.40		6.70	0.252		0.263	
е		2.28			0.090		
e1	4.40		4.60	0.173		0.181	
Н		16.10			0.634		
L	9		9.60	0.354		0.377	
L1	0.8		1.20	0.031		0.047	
L2		0.80	1.25		0.031	0.049	
V1		10°			10°		

Ordering information FLC01

3 Ordering information

Figure 12. Order information scheme

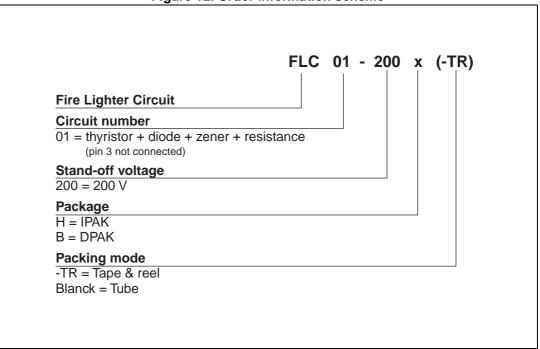


Table 8. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
FLC01-200H	FLC01-200H	IPAK	0.4 g	75	Tube
FLC01-200B	FLC01-200B	DPAK	0.3 g	75	Tube
FLC01-200B-TR	FLC01-200B	DPAK	0.3 g	2500	Tape and reel

4 Revision history

Table 9. Document revision history

Date	Revision	Changes
April-2002	6C	First issue.
27-May-2014	7	Updated DPAK and IPAK package information and reformatted to current standard.

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